

AUTOSWITCHING POWER MUX

Check for Samples: TPS2114A, TPS2115A

FEATURES

- Two-Input, One-Output Power Multiplexer with Low r_{DS(on)} Switches:
 - 120 mΩ Typ (TPS2114A)
 - 84 mΩ Typ (TPS2115A)
- · Reverse and Cross-Conduction Blocking
- Wide Operating Voltage Range: 2.8 V to 5.5 V
- Low Standby Current: 0.5-µA Typ
 Low Operating Current: 55-µA Typ
- Adjustable Current Limit
- Controlled Output Voltage Transition Times Limit Inrush Current and Minimize Output Voltage Hold-Up Capacitance
- CMOS- and TTL-Compatible Control Inputs
- Manual and Auto-Switching Operating Modes
- Thermal Shutdown
- Available in TSSOP-8 and 3-mm x 3-mm SON-8 Packages

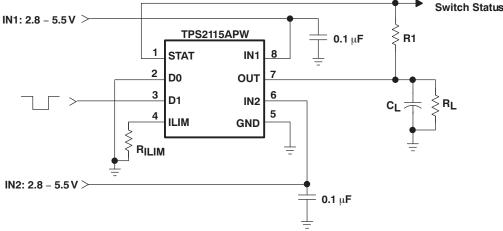
APPLICATIONS

- PCs
- PDAs
- Digital Cameras
- Modems
- Cell Phones
- Digital Radios
- MP3 Players

DESCRIPTION

The TPS211xA family of power multiplexers enables seamless transition between two power supplies (such as a battery and a wall adapter), each operating at 2.8 V to 5.5 V and delivering up to 2 A, depending on package. The TPS211xA family includes extensive protection circuitry, including user-programmable current limiting, thermal protection, inrush current control, seamless supply transition, cross-conduction blocking, and reverse-conduction blocking. These features greatly simplify designing power multiplexer applications.

TYPICAL APPLICATION



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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DEVICE INFORMATION⁽¹⁾

| T _A | PACKAGE | I _{OUT} | ORDERING NUMBER | MARKING |
|----------------|--------------|------------------|-----------------|---------|
| | TCCOD 9 (DW) | 0.75 | TPS2114APW | 2114A |
| -40°C to 85°C | TSSOP-8 (PW) | 1.25 | TPS2115APW | 2115A |
| | SON-8 (DRB) | 2 | TPS2115ADRB | CGF |

⁽¹⁾ For the most current package and ordering information see the Package Option Addendum at the end of this document, or visit the device product folder at www.ti.com.

ABSOLUTE MAXIMUM RATINGS(1)

Over recommended junction temperature range (unless otherwise noted).

| | | VALUE | | |
|-------------------|-----------------------------------------------------------|---------------|----------------|----------|
| | | MIN | MAX | UNIT |
| Voltage | IN1, IN2, D0, D1, ILIM ⁽²⁾ | -0.3 | 6 | V |
| Voltage | V _{O(OUT)} , V _{O(STAT)} ⁽²⁾ | -0.3 | 6 | V |
| | Output sink, I _{O(STAT)} | | 5 | mA |
| | Continuous output, I _O (TPS2114APW) | | 0.9 | А |
| Current | Continuous output, I _O (TPS2115APW) | | 1.5 | А |
| | Continuous output, I_0 (TPS2115ADRB), $T_J \le 105$ °C | | 2.5 | А |
| Power dissipation | Continuous total | See Power Dis | sipation Ratin | gs table |
| Temperature | Operating virtual junction, T _J | -40 | 125 | °C |
| ECD actions | Human body model, HBM | | 2 | kV |
| ESD ratings | Charge device model, CDM | | 500 | V |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated is not implied. Exposure to absolute-maximum rated conditions for extended periods may affect device reliability.

AVAILABLE OPTIONS

| FEATURE | | TPS2114A | TPS2115A |
|--------------------------------|-----------|------------------|---------------|
| Current limit adjustment range | | 0.31 A to 0.75 A | 0.63 A to 2 A |
| Contabio a manda a | Manual | Yes | Yes |
| Switching modes | Automatic | Yes | Yes |
| Switch status output | | Yes | Yes |
| Package | | TSSOP-8 | TSSOP-8 |
| | | 1330F-6 | SON-8 |

⁽²⁾ All voltages are with respect to GND.

www.ti.com

PACKAGE DISSIPATION RATINGS

| PACKAGE | DERATING FACTOR ABOVE T _A = 25°C | T _A ≤ 25°C POWER RATING | T _A = 70°C POWER RATING | T _A = 85°C POWER RATING |
|--------------|------------------------------------------------|---------------------------------------|---------------------------------------|---------------------------------------|
| TSSOP-8 (PW) | 3.9 mW/°C | 387 mW | 213 mW | 155 mW |
| SON-8 (DRB) | 25.0 mW/°C | 2.50 W | 1.38 W | 1.0 W |

RECOMMENDED OPERATING CONDITIONS

| | | MIN | NOM MAX | UNIT |
|------------------------------------------------------------|-------------------------------------|------|---------|------|
| Input voltage at INIA V | V _{I(IN2)} ≥ 2.8 V | 1.5 | 5.5 | V |
| Input voltage at IN1, V _{I(IN1)} | $V_{I(IN2)} < 2.8 \text{ V}$ | 2.8 | 5.5 | V |
| Input voltage at IN2 V | V _{I(IN1)} ≥ 2.8 V | 1.5 | 5.5 | V |
| Input voltage at IN2, V _{I(IN2)} | V _{I(IN1)} < 2.8 V | 2.8 | 5.5 | V |
| Input voltage, V _{I(DO)} , V _{I(D1)} | | 0 | 5.5 | V |
| | TPS2114APW | 0.31 | 0.75 | Α |
| Nominal current limit adjustment range, $I_{O(OUT)}^{(1)}$ | TPS2115APW | 0.63 | 1.25 | Α |
| -0(001) | TPS2115ADRB, T _J ≤ 105°C | 0.63 | 2 | Α |
| Operating virtual junction temperature, T _J | | -40 | 125 | °C |

⁽¹⁾ Minimum recommended current is based on accuracy considerations.

ELECTRICAL CHARACTERISTICS: POWER SWITCH

Over recommended operating junction temperature range, $V_{I(IN1)} = V_{I(IN2)} = 5.5 \text{ V}$, and $R_{ILIM} = 400 \Omega$, unless otherwise noted.

| | | | Т | TPS2114A | | | TPS2115A | | |
|------------------------------------|-----------------------|-------------------------------------------------------------------------|-----|----------|-----|-----|----------|-----|------|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| | | $T_J = 25^{\circ}C$, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 5.0$ V | | 120 | 140 | | 84 | 110 | mΩ |
| | | $T_J = 25^{\circ}C$, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 3.3$ V | | 120 | 140 | | 84 | 110 | mΩ |
| - (1) | Drain-source on-state | $T_J = 25^{\circ}C$, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 2.8$ V | | 120 | 140 | | 84 | 110 | mΩ |
| r _{DS(on)} ⁽¹⁾ | resistance (INx-OUT) | $T_J = 125$ °C, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 5.0$ V | | | 220 | | | 150 | mΩ |
| | | $T_J = 125$ °C, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 3.3$ V | | | 220 | | | 150 | mΩ |
| | | $T_J = 125$ °C, $I_L = 500$ mA, $V_{I(IN1)} = V_{I(IN2)} = 2.8$ V | | | 220 | | | 150 | mΩ |

⁽¹⁾ The TPS211xA can switch a voltage as low as 1.5 V as long as there is a minimum of 2.8 V at one of the input power pins. In this specific case, the lower supply voltage has no effect on the IN1 and IN2 switch on-resistances.



ELECTRICAL CHARACTERISTICS: GENERAL

Over recommended operating junction temperature range, $V_{U(NL)} = V_{U(NL)} = 5.5 \text{ V}$, and $R_{U,IM} = 400 \Omega$, unless otherwise noted.

| | | | TPS2114A | | | |
|-----------------|-------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|------|------|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| OGIC IN | IPUTS (D0 AND D1) | , | | | | |
| / _{IH} | High-level input voltage | | 2 | | | V |
| / _{IL} | Low-level input voltage | | | | 0.7 | V |
| | Innuit current at DO or D1 | D0 or D1 = high, sink current | | | 1 | μΑ |
| | Input current at D0 or D1 | D0 or D1 = low, source current | 0.5 | 1.4 | 5 | μA |
| UPPLY | AND LEAKAGE CURRENTS | | | | | |
| | | D1 = high, D0 = low (IN1 active), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | 55 | 90 | μΑ |
| | Supply current from IN1 | D1 = high, D0 = low (IN1 active), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A | | 1 | 12 | μΑ |
| | (operating) | D0 = D1 = low (IN2 active), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | | 75 | μΑ |
| | | D0 = D1 = low (IN2 active), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A | | | 1 | μΑ |
| | | D1 = high, D0 = low (IN1 active), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | | 1 | μΑ |
| | Supply current from IN2 | D1 = high, D0 = low (IN1 active), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A | | | 75 | μΑ |
| | (operating) | D0 = D1 = low (IN2 active), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | 1 | 12 | μΑ |
| | | $\begin{array}{l} {\rm D0} = {\rm D1} = {\rm low} \; ({\rm IN2} \; {\rm active}), \; {\rm V_{I(IN1)}} = 3.3 \; {\rm V}, \\ {\rm V_{I(IN2)}} = 5.5 \; {\rm V}, \; {\rm I_{O(OUT)}} = 0 \; {\rm A} \end{array}$ | | 55 | 90 | μΑ |
| | Quiescent current from IN1 | D0 = D1 = high (inactive), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | 0.5 | 2 | μΑ |
| | (STANDBY) | D0 = D1 = high (inactive), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A | | | 1 | μΑ |
| | Quiescent current from IN2 | D0 = D1 = high (inactive), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A | | | 1 | μΑ |
| | (STANDBY) | D0 = D1 = high (inactive), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A | | 0.5 | 2 | μΑ |
| | Forward leakage current from IN1 (measured from OUT to GND) | $\begin{array}{l} \text{D0} = \text{D1} = \text{high (inactive), V}_{\text{I(IN1)}} = 5.5 \text{ V, IN2 open,} \\ \text{V}_{\text{O(OUT)}} = 0 \text{ V (shorted), T}_{\text{J}} = 25^{\circ}\text{C} \end{array}$ | | 0.1 | 5 | μΑ |
| | Forward leakage current from IN2 (measured from OUT to GND) | D0 = D1= high (inactive), $V_{I(IN2)}$ = 5.5 V, IN1 open, $V_{O(OUT)}$ = 0 V (shorted), T_J = 25°C | | 0.1 | 5 | μΑ |
| | Reverse leakage current to INx (measured from INx to GND) | D0 = D1 = high (inactive), $V_{I(INx)}$ = 0 V, $V_{O(OUT)}$ = 5.5 V, T_J = 25°C | | 0.3 | 5 | μΑ |
| URREN | IT LIMIT CIRCUIT | | | | | |
| | Current limit acquired, TDC0444A | $R_{ILIM} = 400 \Omega$ | 0.51 | 0.63 | 0.80 | Α |
| | Current limit accuracy, TPS2114A | R _{ILIM} = 700 Ω | 0.30 | 0.36 | 0.50 | Α |
| | Current limit accuracy, TPS2115A | $R_{ILIM} = 400 \Omega$ | 0.95 | 1.25 | 1.56 | Α |
| | Current limit accuracy, 1F32113A | $R_{ILIM} = 700 \Omega$ | 0.47 | 0.71 | 0.99 | Α |
| | Current limit settling time | Time for short-circuit output current to settle within 10% of its steady state value. | | 1 | | ms |
| | Input current at ILIM | $V_{I(ILIM)} = 0 \text{ V}, I_{O(OUT)} = 0 \text{ A}$ | -15 | | 0 | μΑ |
| VLO | | | | | | |
| | IN1 and IN2 UVLO | Falling edge | 1.15 | 1.25 | | V |
| | 111 and 1142 OVEO | Rising edge | | 1.30 | 1.35 | V |
| _ | IN1 and IN2 UVLO hysteresis | | 30 | 57 | 65 | mV |
| - | Internal V _{DD} UVLO (the higher of | Falling edge | 2.4 | 2.53 | | V |
| | IN1 and IN2) | Rising edge | | 2.58 | 2.8 | V |
| | Internal V _{DD} UVLO hysteresis | | 30 | 50 | 75 | mV |
| - | UVLO deglitch for IN1, IN2 | Falling edge | | 110 | | μs |



ELECTRICAL CHARACTERISTICS: GENERAL (continued)

Over recommended operating junction temperature range, $V_{I(IN1)} = V_{I(IN2)} = 5.5 \text{ V}$, and $R_{II IM} = 400 \Omega$, unless otherwise noted.

| | | | TPS2114A | | | |
|--------------------------|---------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|-----|------|
| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| REVERSE (| CONDUCTION BLOCKING | | | | | |
| $\Delta V_{O(I_block)}$ | Minimum input-to-output voltage difference to block switching | $\begin{array}{l} D0 = D1 = high, \ V_{I(INx)} = 3.3 \ V \\ Connect \ OUT \ to \ a \ 5-V \ supply \ through \ a \ series \ 1-k\Omega \\ resistor. \ Let \ D0 = low. \ Slowly \ decrease \ the \ supply \ voltage \\ until \ OUT \ connects \ to \ IN1. \end{array}$ | 80 | 100 | 120 | mV |
| THERMAL | SHUTDOWN | | | | | |
| | Thermal shutdown threshold | TPS211xA is in current limit | 135 | | | °C |
| | Recovery from thermal shutdown | TPS211xA is in current limit | 125 | | | °C |
| | Hysteresis | | | 10 | | °C |
| IN2-IN1 CO | MPARATORS | | | | | |
| | Hysteresis of IN2-IN1 comparator | | 0.1 | | 0.2 | V |
| | Deglitch of IN2-IN1 comparator (both ↑↓) | | 10 | 20 | 50 | μs |
| STAT OUT | PUT | | | | | |
| | Leakage current | V _{O(STAT)} = 5.5 V | | 0.01 | 1 | μA |
| | Saturation voltage | I _{I(STAT)} = 2 mA, IN1 switch is on | | 0.13 | 0.4 | V |
| | Deglitch time (falling edge only) | | | 150 | | μs |

SWITCHING CHARACTERISTICS

Over recommended operating junction temperature range, $V_{I(IN1)} = V_{I(IN2)} = 5.5 \text{ V}$, and $R_{ILIM} = 400 \Omega$, unless otherwise noted.

| | | | TI | | | TPS2115A | | | |
|--------------------------|-------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|-----|----------|-----|-----|------|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| POWE | R SWITCH | | - | | | | | | |
| t _r | Output rise time from an enable | $V_{I(IN1)}=V_{I(IN2)}=5$ V, $T_J=25^{\circ}C,~C_L=1~\mu F,~I_L=500~mA$ (see Figure 1a) | 0.5 | 1.0 | 1.5 | 1 | 1.8 | 3 | ms |
| t _f | Output fall time from a disable | $V_{I(IN1)}=V_{I(IN2)}=5$ V, $T_J=25^{\circ}C,~C_L=1~\mu F,~I_L=500~mA$ (see Figure 1a) | 0.35 | 0.5 | 0.7 | 0.5 | 1 | 2 | ms |
| t _t Transitio | Transition time | IN1 to IN2 transition, $V_{I(IN1)}=3.3$ V, $V_{I(IN2)}=5$ V, $T_J=125^{\circ}$ C, $C_L=10$ μ F, $I_L=500$ mA Measure transition time as 10–90% rise time or from 3.4 V to 4.8 V on $V_{O(OUT)}$ (see Figure 1b). | | 40 | 60 | | 40 | 60 | μs |
| | Transition time | IN2 to IN1 transition, $V_{I(IN1)}=5$ V, $V_{I(IN2)}=3.3$ V, $T_J=125^{\circ}$ C, $C_L=10$ μ F, $I_L=500$ mA Measure transition time as 10–90% rise time or from 3.4 V to 4.8 V on $V_{O(OUT)}$ (see Figure 1b). | | 40 | 60 | | 40 | 60 | μs |
| t _{PLH1} | Turn-on propagation delay from enable | $V_{I(IN1)}=V_{I(IN2)}=5$ V, measured from enable to 10% of $V_{O(OUT)},$ $T_J=25^{\circ}C,$ $C_L=10~\mu\text{F},$ $I_L=500~\text{mA}$ (see Figure 1a) | | 0.5 | | | 1 | | ms |
| t _{PHL1} | Turn-off propagation delay from a disable | $V_{I(IN1)}=V_{I(IN2)}=5$ V, measured from disable to 90% of $V_{O(OUT)},T_J=25^{\circ}C,C_L=10~\mu\text{F},I_L=500~\text{mA}$ (see Figure 1a) | | 3 | | | 5 | | ms |
| t _{PLH2} | Switch-over rising propagation delay | Logic 1 to Logic 0 transition on D1, $V_{I(IN1)}$ = 1.5 V, $V_{I(IN2)}$ = 5 V, $V_{I(D0)}$ = 0 V, measured from D1 to 10% of $V_{O(OUT)}$, T_J = 25°C, C_L = 10 μ F, I_L = 500 mA (see Figure 1c) | | 40 | 100 | | 40 | 100 | μs |
| t _{PHL2} | Switch-over falling propagation delay | Logic 0 to Logic 1 transition on D1, $V_{1(IN1)}$ = 1.5V, $V_{1(IN2)}$ = 5V, $V_{1(D0)}$ = 0 V, measured from D1 to 90% of $V_{O(OUT)}$, T_J = 25°C, C_L = 10 μ F, I_L = 500 mA (see Figure 1c) | 2 | 3 | 10 | 2 | 5 | 10 | ms |

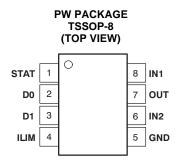


Table 1. Truth Table

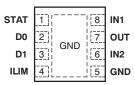
| D1 | D0 | $V_{I(IN2)} > V_{I(IN1)}$ | STAT | OUT ⁽¹⁾ |
|----|----|---------------------------|------|--------------------|
| 0 | 0 | X ⁽²⁾ | Hi-Z | IN2 |
| 0 | 1 | No | 0 | IN1 |
| 0 | 1 | Yes | Hi-Z | IN2 |
| 1 | 0 | X | 0 | IN1 |
| 1 | 1 | X | 0 | Hi-Z |

- (1) The under-voltage lockout circuit causes the output OUT to go Hi-Z if the selected power supply does not exceed the IN1/IN2 UVLO, or if neither of the supplies exceeds the internal V_{DD} UVLO.
- (2) X = Don't care.

PIN CONFIGURATIONS



DRB PACKAGE 3mm × 3mm SON-8 (TOP VIEW)

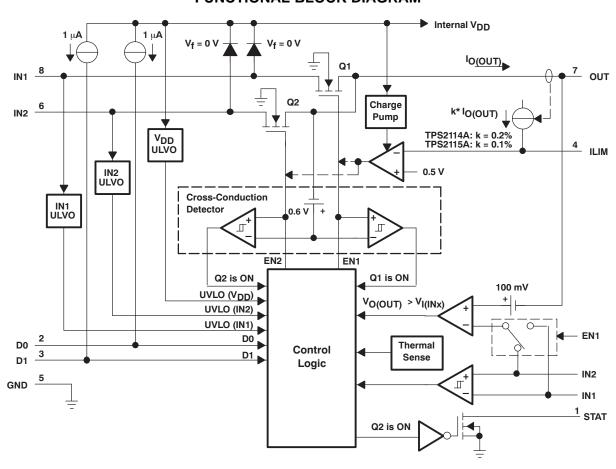


TERMINAL FUNCTIONS

| TER | RMINAL | | |
|------|--------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME | NO. | 1/0 | DESCRIPTION |
| D0 | 2 | I | TTL- and CMOS-compatible input pins. Each pin has a 1-µA pull-up. Table 1 illustrates the functionality of D0 and D1. |
| D1 | 3 | I | TTL- and CMOS-compatible input pins. Each pin has a 1-µA pull-up. Table 1 illustrates the functionality of D0 and D1. |
| GND | 5 | I | Ground |
| IN1 | 8 | I | Primary power switch input. The IN1 switch can be enabled only if the IN1 supply is above the UVLO threshold and at least one supply exceeds the internal V _{DD} UVLO. |
| IN2 | 6 | I | Secondary power switch input. The IN2 switch can be enabled only if the IN2 supply is above the UVLO threshold and at least one supply exceeds the internal V _{DD} UVLO. |
| ILIM | 4 | I | A resistor $R_{\rm ILIM}$ from ILIM to GND sets the current limit $I_{\rm L}$ to 250/ $R_{\rm ILIM}$ and 500/ $R_{\rm ILIM}$ for the TPS2114A and TPS2115A, respectively. |
| OUT | 7 | 0 | Power switch output |
| STAT | 1 | 0 | STAT is an open-drain output that is Hi-Z if the IN2 switch is ON. STAT pulls low if the IN1 switch is ON or if OUT is Hi-Z (i.e., EN is equal to logic 0). |
| PAD | _ | I | Tie to GND. Connect to internal planes for improved heatsinking with multiple vias. |

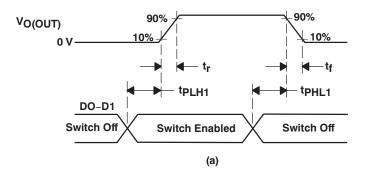


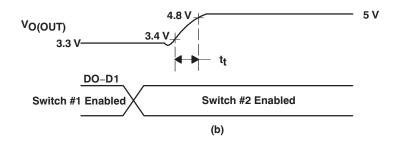
FUNCTIONAL BLOCK DIAGRAM





PARAMETER MEASUREMENT INFORMATION





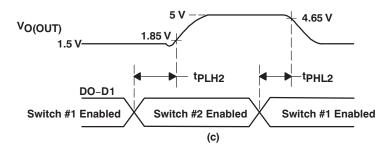


Figure 1. Propagation Delays and Transition Timing Waveforms



TYPICAL CHARACTERISTICS

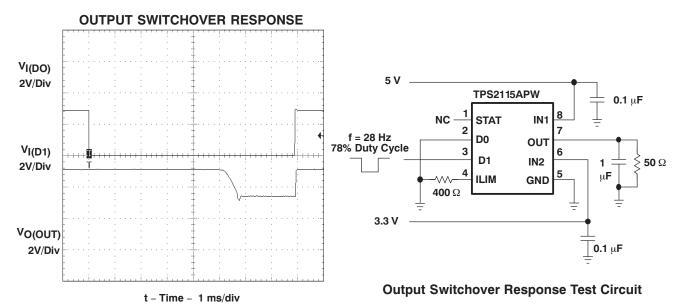


Figure 2.

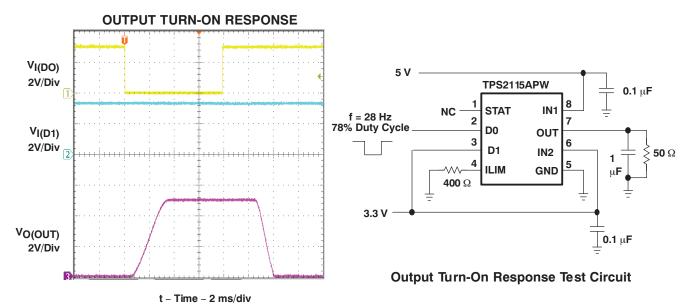


Figure 3.



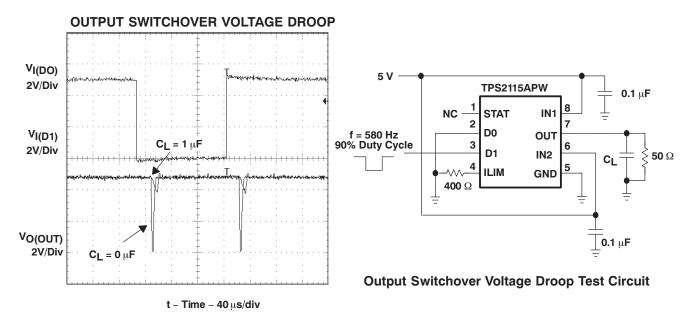
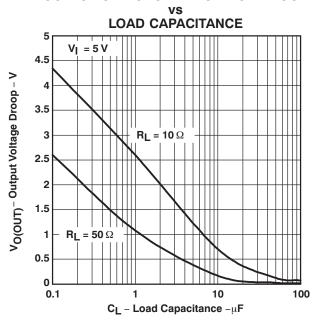
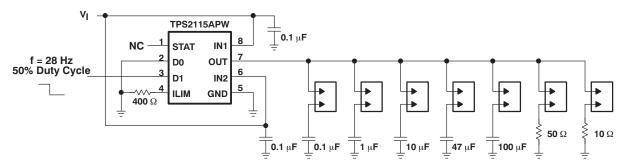


Figure 4.



OUTPUT SWITCHOVER VOLTAGE DROOP





Output Switchover Voltage Droop Test Circuit Figure 5.



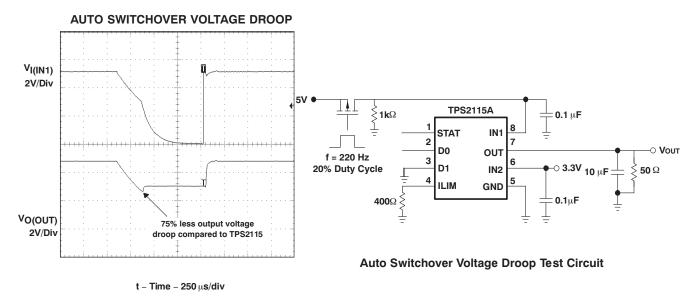
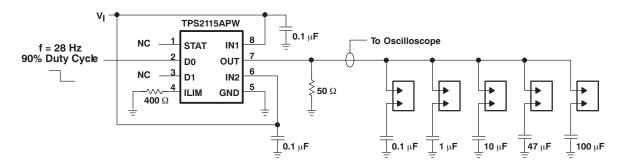


Figure 6.

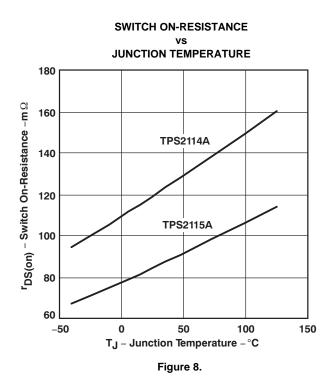


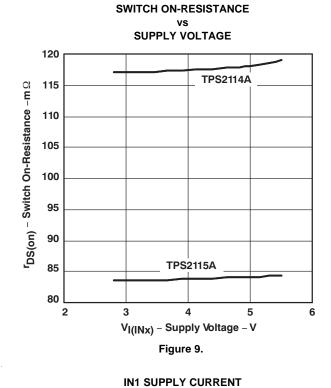
INRUSH CURRENT vs LOAD CAPACITANCE 300 250 I - Inrush Current - mA 200 V_I = 5 V 150 $V_I = 3.3 V$ 100 50 0 0 20 60 80 100 C_L - Load Capacitance -µF

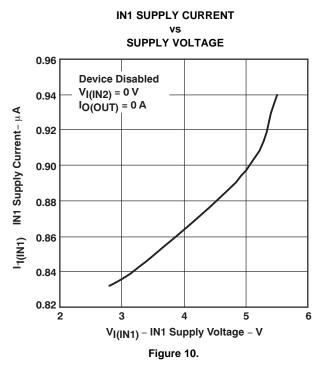


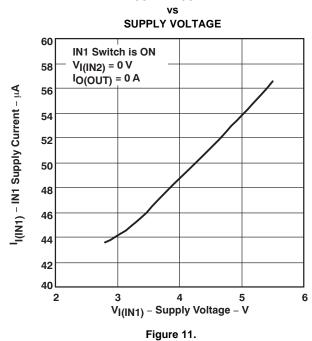
Output Capacitor Inrush Current Test Circuit Figure 7.



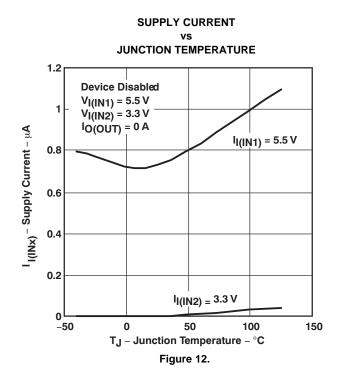


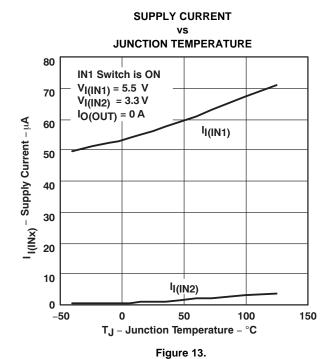














APPLICATION INFORMATION

Some applications have two energy sources, one of which should be used in preference to another. Figure 14 shows a circuit that will connect IN1 to OUT until the voltage at IN1 falls below a user-specified value. Once the voltage on IN1 falls below this value, the TPS2114A/5A will select the higher of the two supplies. This usually means that the TPS2114A/5A will swap to IN2.

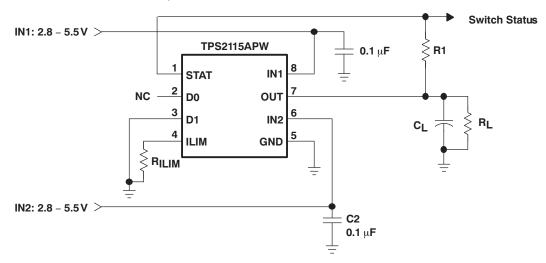


Figure 14. Auto-Selecting for a Dual Power Supply Application

In Figure 15, the multiplexer selects between two power supplies based upon the D1 logic signal. OUT connects to IN1 if D1 is logic 1; otherwise, OUT connects to IN2. The logic thresholds for the D1 terminal are compatible with both TTL and CMOS logic.

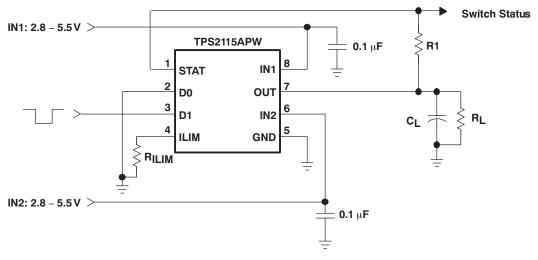


Figure 15. Manually Switching Power Sources

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DETAILED DESCRIPTION

AUTO-SWITCHING MODE

D0 equal to logic 1 and D1 equal to logic 0 selects the auto-switching mode. In this mode, OUT connects to the higher of IN1 and IN2.

MANUAL SWITCHING MODE

D0 equal to logic 0 selects the manual-switching mode. In this mode, OUT connects to IN1 if D1 is equal to logic 1, otherwise OUT connects to IN2.

N-CHANNEL MOSFETs

Two internal high-side power MOSFETs implement a single-pole double-throw (SPDT) switch. Digital logic selects the IN1 switch, IN2 switch, or no switch (Hi-Z state). The MOSFETs have no parallel diodes so output-to-input current cannot flow when the FET is off. An integrated comparator prevents turn-on of a FET switch if the output voltage is greater than the input voltage.

CROSS-CONDUCTION BLOCKING

The switching circuitry ensures that both power switches will never conduct at the same time. A comparator monitors the gate-to-source voltage of each power FET and allows a FET to turn on only if the gate-to-source voltage of the other FET is below the turn-on threshold voltage.

REVERSE-CONDUCTION BLOCKING

When the TPS211xA switches from a higher-voltage supply to a lower-voltage supply, current can potentially flow back from the load capacitor into the lower-voltage supply. To minimize such reverse conduction, the TPS211xA will not connect a supply to the output until the output voltage has fallen to within 100 mV of the supply voltage. Once a supply has been connected to the output, it will remain connected regardless of output voltage.

CHARGE PUMP

The higher of supplies IN1 and IN2 powers the internal charge pump. The charge pump provides power to the current limit amplifier and allows the output FET gate voltage to be higher than the IN1 and IN2 supply voltages. A gate voltage that is higher than the source voltage is necessary to turn on the N-channel FET.

CURRENT LIMITING

A resistor R_{ILIM} from ILIM to GND sets the current limit to 250/R_{ILIM} and 500/R_{ILIM} for the TPS2114A and TPS2115A, respectively. Setting resistor R_{ILIM} equal to zero is not recommended as that disables current limiting.

OUTPUT VOLTAGE SLEW-RATE CONTROL

The TPS2114A/5A slews the output voltage at a slow rate when OUT switches to IN1 or IN2 from the Hi-Z state (see Table 1). A slow slew rate limits the inrush current into the load capacitor. High inrush currents can glitch the voltage bus and cause a system to hang up or reset. It can also cause reliability issues—like pit the connector power contacts, when hot-plugging a load such as a PCI card. The TPS2114A/5A slews the output voltage at a much faster rate when OUT switches between IN1 and IN2. The fast rate minimizes the output voltage droop and reduces the output voltage hold-up capacitance requirement.

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|-----------------------------------------------------------|
| | Dimension designed to accommodate the component length |
| | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| All difficusions are nominal | | | | | | | | | | | | |
|------------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| TPS2114APWR | TSSOP | PW | 8 | 2000 | 330.0 | 12.4 | 7.0 | 3.6 | 1.6 | 8.0 | 12.0 | Q1 |
| TPS2115ADRBR | SON | DRB | 8 | 3000 | 330.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |
| TPS2115ADRBT | SON | DRB | 8 | 250 | 180.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |
| TPS2115APWR | TSSOP | PW | 8 | 2000 | 330.0 | 12.4 | 7.0 | 3.6 | 1.6 | 8.0 | 12.0 | Q1 |

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*All dimensions are nominal

| 7 III GITTIOTOTOTO GITO TIOTITICA | | | | | | | |
|-----------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| TPS2114APWR | TSSOP | PW | 8 | 2000 | 367.0 | 367.0 | 35.0 |
| TPS2115ADRBR | SON | DRB | 8 | 3000 | 367.0 | 367.0 | 35.0 |
| TPS2115ADRBT | SON | DRB | 8 | 250 | 210.0 | 185.0 | 35.0 |
| TPS2115APWR | TSSOP | PW | 8 | 2000 | 367.0 | 367.0 | 35.0 |



REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | hanges from Revision E (April 2011) to Revision F | Page |
|---|----------------------------------------------------------------------------------------------------------------------------------|----------------|
| • | Changed description of power supplies in <i>Description</i> section | 1 |
| • | Added I _{OUT} column to Device Information table | <mark>2</mark> |
| • | Changed conditions of Absolute Maximum Ratings table | <mark>2</mark> |
| • | Added PW to end of device name in first two continuous output rows in <i>Current</i> parameter of Absolute Maximum Ratings table | 2 |
| • | Added last continuous output row to Current parameter in Absolute Maximum Ratings table | <u>2</u> |
| • | Deleted storage temperature row from Absolute Maximum Ratings table | <u>2</u> |
| • | Changed Current limit adjustment range parameter, TPS2115A specification in Available Options table | <u>2</u> |
| • | Changed Nominal current limit adjustment range parameter in Recommended Operating Conditions table | 3 |
| • | Added footnote 1 to Recommended Operating Conditions table | 3 |
| C | hanges from Revision D (July 2006) to Revision E | Page |
| • | Updated document to current format | 1 |
| • | Changed title, footnote, and CGF marking in Device Information table | 2 |
| • | Deleted footnote 1 (not tested in production) from Electrical Characteristics: General table | 4 |
| • | Deleted footnote 1 (not tested in production) from Switching Characteristics table | 5 |
| • | Added PAD row to Terminal Functions table | 6 |

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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| | | | | | | | (6) | | | | |
| TPS2114APW | ACTIVE | TSSOP | PW | 8 | 150 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 2114A | Samples |
| TPS2114APWR | ACTIVE | TSSOP | PW | 8 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 2114A | Samples |
| TPS2115ADRBR | ACTIVE | SON | DRB | 8 | 3000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | CGF | Samples |
| TPS2115ADRBT | ACTIVE | SON | DRB | 8 | 250 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | CGF | Samples |
| TPS2115ADRBTG4 | ACTIVE | SON | DRB | 8 | 250 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | CGF | Samples |
| TPS2115APW | ACTIVE | TSSOP | PW | 8 | 150 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 2115A | Samples |
| TPS2115APWR | ACTIVE | TSSOP | PW | 8 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 2115A | Samples |
| TPS2115APWRG4 | ACTIVE | TSSOP | PW | 8 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 2115A | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.





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(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF TPS2115A:

Automotive: TPS2115A-Q1

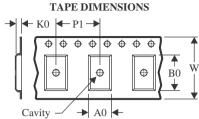
NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

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TAPE AND REEL INFORMATION

REEL DIMENSIONS Reel Diameter Reel Width (W1)



| A0 | Dimension designed to accommodate the component width |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS2114APWR | TSSOP | PW | 8 | 2000 | 330.0 | 12.4 | 7.0 | 3.6 | 1.6 | 8.0 | 12.0 | Q1 |
| TPS2115ADRBR | SON | DRB | 8 | 3000 | 330.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |
| TPS2115ADRBT | SON | DRB | 8 | 250 | 180.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |
| TPS2115APWR | TSSOP | PW | 8 | 2000 | 330.0 | 12.4 | 7.0 | 3.6 | 1.6 | 8.0 | 12.0 | Q1 |

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|-----------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| TPS2114APWR | TSSOP | PW | 8 | 2000 | 356.0 | 356.0 | 35.0 |
| TPS2115ADRBR | SON | DRB | 8 | 3000 | 367.0 | 367.0 | 35.0 |
| TPS2115ADRBT | SON | DRB | 8 | 250 | 210.0 | 185.0 | 35.0 |
| TPS2115APWR | TSSOP | PW | 8 | 2000 | 356.0 | 356.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TPS2114APW | PW | TSSOP | 8 | 150 | 530 | 10.2 | 3600 | 3.5 |
| TPS2115APW | PW | TSSOP | 8 | 150 | 530 | 10.2 | 3600 | 3.5 |



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4203482/L





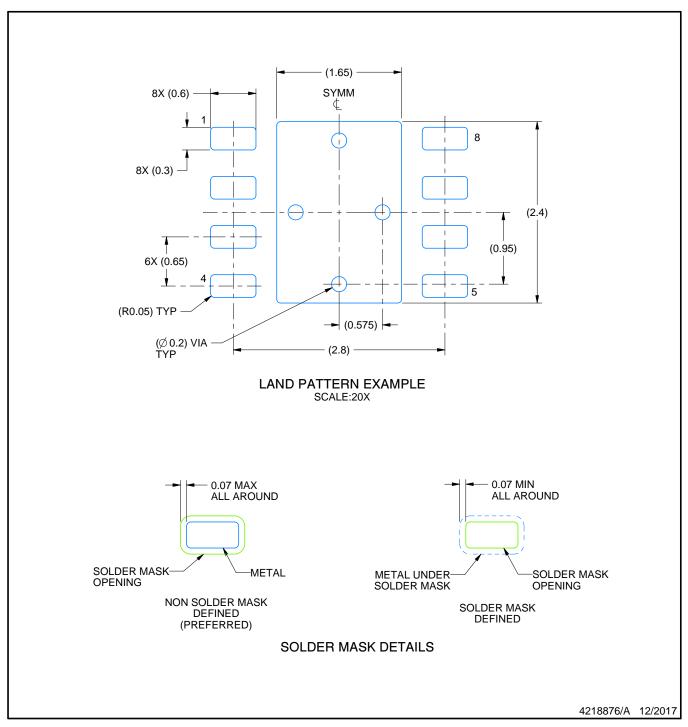
PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

PLASTIC SMALL OUTLINE - NO LEAD

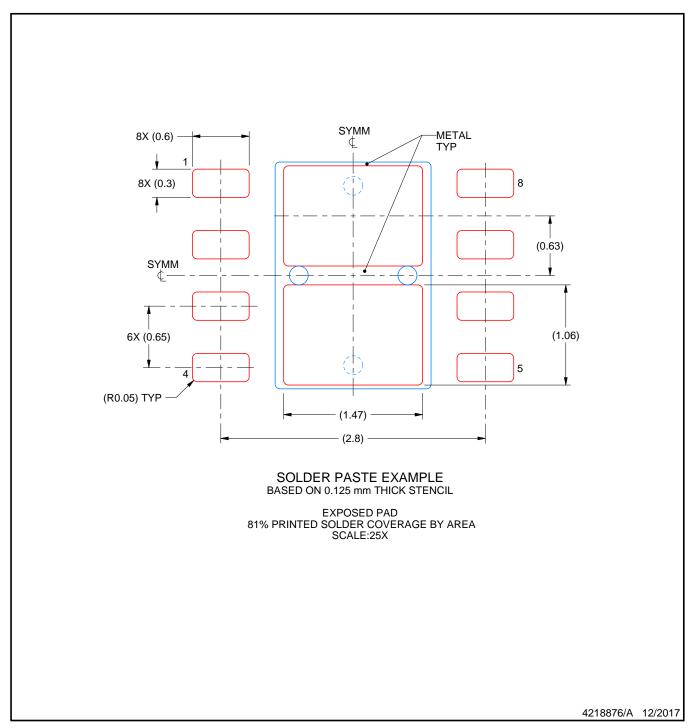


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC SMALL OUTLINE - NO LEAD

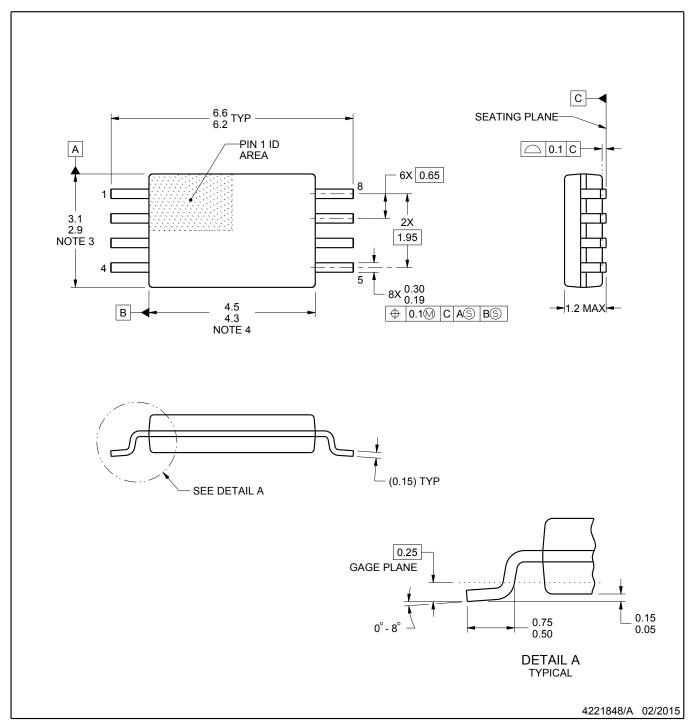


NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153, variation AA.



SMALL OUTLINE PACKAGE

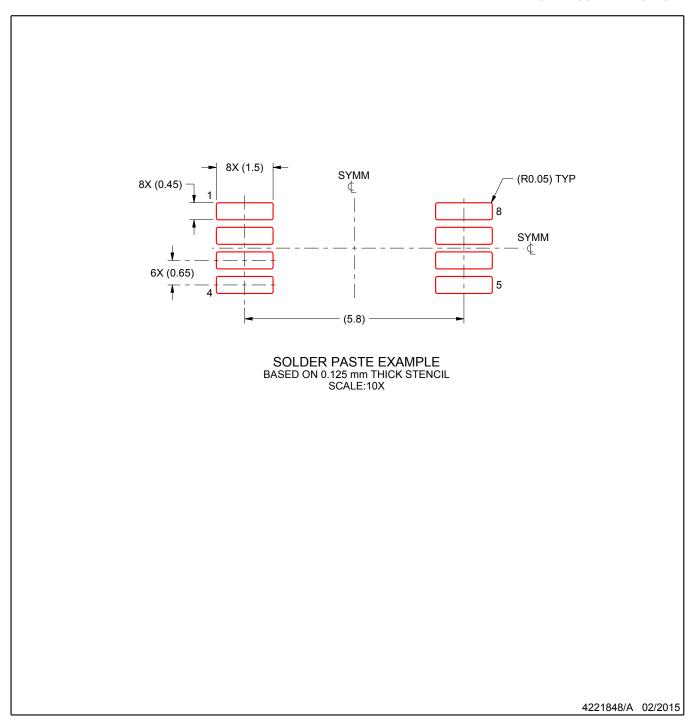


NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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